

ISQED'22 Final Call for Papers

ISQED'22 Final Call for Paper Deadline has been extended to Nov. 20, 2021

SAN JOSE, CALIFORNIA, USA, November 12, 2021 /EINPresswire.com/ --ISQED'22 Final Call for Papers Final Deadline: Nov. 20, 2021 Conference Highlights Al/ML & Electronic Design, Security, IoT, Autonomous Vehicles, Quantum Computing

Symposium on Quality Electronic Design (ISQED) is announcing the final paper submission deadline for ISQED'22 to Nov. 20. All papers submitted by this week, will have one



more week to submit the revised work. ISQED is an internationally reputable conference, sponsored by <u>IEEE</u> CASS, IEEE EDS, and IEEE Reliability Societies, and in cooperation with ACM/SigDA. The conference is planned to be held as a virtual event on April 2022 in Santa Clara, CA, USA.

A partial list of topics of interest includes:

Hardware and System Security Attacks and countermeasures including but not limited to side-channel attacks, reverse engineering, tampering, and Trojans Hardware-based security primitives including PUFs, TRNGs and ciphers Security, privacy, trust protocols, and trusted information flow Ensuring trust using untrusted tools, IP, models and manufacturing Secure hardware architectures Secure memory systems Post-quantum security primitives Security challenges and opportunities of emerging nanoscale devices IoT and cyber-physical system security Any other topics related to hardware security

Electronic Design Automation Tools and Methodologies EDA and physical design tools, processes, methodologies, and flows Design tools for analysis/ tolerance of variation, aging, and soft-errors Design and maintenance of hard and soft IP blocks Challenges and solutions of integrating, testing, qualifying and manufacturing IP blocks from multiple vendors EDA for non-traditional problems such as smart power grid and solar energy EDA tools and methodologies for 3D integrations, and advanced packaging Modeling and Simulation of Semiconductor Processes and Devices (TCAD) CAD for bio-inspired and neuromorphic systems EDA tools, methodologies and applications for Photonics devices, circuit and system design EDA for MEMS Any other topics related design automation tools and methodologies **Design Test and Verification** Hardware and software formal-, assertion-, and simulation-based design verification techniques All areas of DFT, ATE and BIST for digital designs, analog/mixed-signal IC's, SoC's, and memories Test synthesis and synthesis for testability Fault diagnosis, IDDQ test, novel test methods, effectiveness of test methods, fault models and ATPG, and DPPM prediction SoC/IP testing strategies Design methodologies dealing with the link between testability and manufacturing Hardware/software co-verification

Advanced methodologies, testbenches, and flows (e.g., UVM, HDLs, HVLs)

Formal and semi-formal verification and validation techniques

Safety and security in verification and validation New methods and tools supporting functional safety and security

Self-checking testbenches in analog verification

Any other topics related to design test and verification

Emerging Device and Process Technologies and Applications

Design, simulation and modeling of emerging technologies

Design, simulation and modeling of emerging non-volatile memory and logic, such as STT-RAM, PC-RAM, R-RAM, and Memristors

Application of emerging devices for storage and computation including but not limited to cognitive, neuromorphic, or quantum computing

Qubit technologies and quantum computing Specialty technologies such as MEMs, NEMs Novel or emerging solid state nano-electronic devices and concepts

Design and Technology Co-Optimization

Optimization-based methodologies that address the interaction between design (custom, semicustom, ASIC, FPGA, RF, memory, etc.) Advanced-node manufacturing techniques such as multiple patterning, EUV lithography, DSA lithography,

Advanced interconnect (e.g., air gap for local interconnect, Si photonics, etc.).

Modeling, analysis, and optimization of technology implications on performance metrics like power consumption, timing, area, and cost.

Design methods and tools to improve yield and manufacturability.

Any other topics related to emerging device technologies and applications

Circuit Design, 3D Integration and Advanced Packaging

Low power, high-performance, and robust design of logic, memory, analog, interconnect, RF, programmable logic, and FPGA circuits

Techniques for leakage control, power optimization, and power management

Analog circuit design including but not limited to all-digital PLLs and DLLs, ADC's and DAC's Adaptive and resilient digital circuits and systems

On-chip process, voltage, temperature, and aging sensors and monitoring

Hardware design for IoT sensors and actuators including digital logic, memory design, wireless communications, energy harvesting, signal processing, and power management

Innovative packaging technologies including 3D IC, 2.5D or interposer, and multi-chip module and their impact on design

Design techniques, methodologies and flows for vertically integrated circuits/chips

Modeling and mitigation of device interactions for 3D ICs

Design of die-to-die interfaces in 3D/2.5D ICs

Design-for-testability and system-level design issues in 3D/2.5D

Die-package co-design

Any other topics related to circuit design, 3D integration and advanced packaging

System-level Design and Methodologies

Methods and tools aiming at quality of systems including multi-core processors, graphics processors embedded systems, SoC, novel accelerator designs, and heterogeneous architecture designs

System-level trade-off analysis and multi-objective (e.g. yield, power, delay, area, etc.) optimization

System level power and thermal management

Exploration of influence of emerging technologies on the system level design

System level modeling and simulation to characterize effects of process, voltage, temperature,

and aging on power, performance, and reliability

Cyber-Physical Systems – Design, Methodologies & Tools

HW/SW co-design, co-simulation, co-optimization, and co-exploration

HW/SW prototyping and emulation on FPGAs

Micro-architectural transformation

System communication architecture

Application driven heterogeneous computing platforms

Network-on-chip design methodologies

Any other topics related to system level design and methodologies

Cognitive Computing Hardware Neuromorphic computing and non-Von Neumann architectures Hardware and architecture for neural networks and system-level design for (deep) neural computing Neural network acceleration techniques including GPGPU, FPGA and dedicated ASICs Safe and secure machine learning Hardware accelerators for Artificial Intelligence Cognitiveinspired computing fundamentals Cognitive-inspired computing systems Cognitive-inspired computing with big data Cognitive-inspired intelligent interaction AI-assisted cognitive computing approaches Brain analysis for cognitive-inspired computing Internet of cognitive Things

Cognitive environment, sensing and data

Cognitive robots and agents Security issue in cognitive-inspired computing

Test-bed, prototype implementation and applications

Any other topics related to cognitive computing hardware

Submission of Papers (Regular, WIP, Special Sessions) For any information about submission process refer to: <u>https://www.isqed.org/English/Conference/Call_for_Papers.html</u>

About ISQED

ISQED'22 is being held with the technical sponsorship of IEEE CASS, EDS, and Reliability Society. ISQED'22 corporate sponsor is <u>Synopsys</u>. All past Conference proceedings & Papers have been published in IEEE Xplore digital library and indexed by Scopus.

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